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LIQUID CRYSTAL DISPLAY DEVICE

BACKGROUND OF THE INVENTION

The present invention relates to a display device, and, more particularly, to a liquid crystal display device.

An active matrix type liquid crystal display device is, for example, configured such that, on one substrate of a pair of substrates which sandwich a liquid crystal layer therebetween, there are a plurality of scanning signal lines, a plurality of video signal lines which cross the plurality of scanning signal lines, and a plurality of pixels arranged in a matrix array [are formed]. Each one of the plurality of pixels includes a switching element which is driven by [the] scanning signal line and a pixel electrode, to which video signals are supplied from [the] video signal line through the switching element. A counter electrode is formed on another substrate (out) of a pair of substrates. [A] state of light which passes through the liquid crystal layer is controlled by driving the liquid crystal using electric fields generated between the counter electrode and the pixel electrodes, thus producing a display of images.

Since the liquid crystal display device is not a self-luminous type display device, an auxiliary light source unit is provided for taking light [in] from the outside of [a] liquid crystal display panel. As one example, there [has been] known a liquid crystal display device in which a backlight is arranged

(the liquid crystal display panel),

on a side opposite to a display screen side (observer side),
so that ^{the} ~~an~~ liquid crystal display panel is illuminated from ^{the} back
surface thereof. However →

Here, when light irradiated from the backlight leaks from
a portion of a gap defined between [the] neighboring pixel
electrodes and an observer observes the leaked light, the
contrast is lowered and the image quality is degraded.

Further, ^a parasitic capacitance is generated between the
video signal line and the pixel electrode. When this parasitic
capacitance is large, a phenomenon which is referred to as a
vertical smear (also referred to as "vertical crosstalk")
becomes apparent and affects the image quality. This vertical
smear is a phenomenon in which, when ^a display is ^{produced} as a white
display window or a black display window, while adopting a half
tone display as a background, the level of the half tone display
at portions of the background at upper and lower sides (vertical
direction) of the window is shifted either in the white display
direction or in the black display direction, and these portions
become different from portions of the background which have
no window in color.

As ^{ways to} ~~the~~ prior art which can solve such a drawback, a
technique disclosed in Japanese Unexamined Patent Publication
209041/2001 (hereinafter referred to as "^{publication} prior art 1"), and a
technique disclosed in Japanese Unexamined Patent Publication
151699/2002 (hereinafter referred to as "^{publication} prior art 2") (are named).

diagram schematically

Fig. 15 is a [plan view] of a pixel portion, showing the technique described in publication [schematic] constitution of the [prior art] 1. Further, Fig. 16 is a cross-sectional view taken along a line E-E' in Fig. 15. Here, in Fig. 15 and Fig. 16, to facilitate [the] understanding of the [schematic] constitution of the [prior art] 1, the [constitution] is simplified by omitting or modifying some constituent elements.

In Fig. 15, a video signal line (data line) DL has a portion which thereof overlaps ~~with~~ ^{with} the pixel electrode PX. However, the video signal line DL has a narrow width portion, where [a] width is narrowed at a portion cut by the E-E' line and the video signal line DL ~~is~~ ^{does} not overlap ~~with~~ ^{with} the pixel electrode PX, as shown in Fig. 16. Accordingly, it is possible to reduce the parasitic capacitance which is generated between the video signal line DL and the pixel electrode PX [by way of], ^{, which are separated by} a second insulation film IN2. structural arrangement between the signal line DL and the pixel electrode PX

However, [only] with the provision of such a [structure], ^{tends to leak} [leaking of] light [is generated] through a gap defined between the pixel electrode PX and the video signal line DL; and, hence, a light shielding film SLD is formed below the narrow width portion of the video signal line DL, ^{, with the film SLD being separated from} by [way of] a first insulation film IN1. By overlapping the light shielding film SLD to the ^{related edge portions of} adjacent pixel electrodes PX, it is possible to block light which is irradiated from a backlight and is incident from a back surface ^{the} of [a] substrate SUB1.

~~technique disclosed in publication~~

Here, in the [prior art] 1, the light shielding film SLD
~~as that~~
is formed of the same material used for forming a storage line
(capacitance line) STL, which generates ^astorage capacitance[], and
the light shielding film SLD and the storage line STL are
electrically insulated from each other. Further, GT indicates
gate electrodes and GL indicates scanning signal lines (scanning
lines).

Fig. 17 is a plan view of a pixel portion showing the
~~technique disclosed in publication~~
[schematic] constitution of the [prior art] 2. Also, in Fig. 17,
~~an~~
to facilitate ~~the~~ understanding of the [schematic] constitution
[of the prior art 2], the ~~constitution~~ ^{structure} is simplified by omitting
or modifying some constituent elements. Here, constitutional
elements corresponding to the constitutional elements ^{shown} in Fig.
15 are given ^{the} same numerals, and ^{their} ^a repeated explanation ^{there will be} (is),
omitted.

To compare the constitution shown in Fig. 17 with the
~~technique of publication~~
constitution shown in Fig. 15, ~~although the~~ [prior art] 2 differs
~~that disclosed in publication~~ ^{the fact} from [the prior art] 1 with respect to ^{with respect to the} [a point] that the width
of the video signal line DL is fixed and ^{but they are} [a] shape of the pixel
electrode PX, ^{in other respects} [the prior art 2 is] substantially equal ^{to the} ^{the} [prior art]. Since [a] cross-sectional view taken along a line
^{the same as that of} ^{an} ^{there will be} F-F' in Fig. 17 is ^{essential difference} equal to Fig. 16, ^{the fact} [the] explanation (is) omitted.
The ^{most different point} lies in that the light shielding
film SLD, which ^s [is] overlapped ^{to} the video signal line DL, is
integrally formed with the storage line STL. Accordingly,

in a state
although the light shielding film SLD is floating in the prior art 1, the light shielding film SLD has the same potential as the storage line STL in the prior art 2.
However, the prior art 1 and the prior art 2 have following drawbacks.

technique of publication
In the prior art 1, since the light shielding film SLD is electrically floating, the prior art suffers from another degradation of images, different from the vertical smear. In the prior art 1, since the light shielding film SLD is floating, along with the change of the potential of the video signal line DL, the potential of the light shielding film SLD will be changed. Here, however, there exists a case in which due to the influence of static electricity or the like, out of a plurality of light shielding films SLD, the potential of only some light shielding films SLD will suddenly change without regard to the change of potential of the video signal line DL. In this case, the potential of some corresponding pixel electrodes PX will be subject to the influence of this change. As a result, this may give rise to a display having gray scales, remarkably different from gray scales of a display around the display, thus degrading the image quality of the display.

technique of publication
In the prior art 2, since the light shielding film SLD is held at the same potential as the storage line STL, a phenomenon which occurs in the prior art 1 does not occur. However, the light shielding film SLD, which is overlapped to the video signal

line DL by way of the first insulation film IN1, is held at a fixed potential, different from ^{that is} ~~the~~ potential of the video signal line DL. As a result, ^{the} load is increased at the time of driving the display device by supplying video signals to the video signal line, the power consumption is increased, and, at the same time, ^{the} the image quality is degraded due to rounding of waveforms.

Accordingly, it is an object of the present invention to provide a display device having ^{an} improved image quality.

SUMMARY OF THE INVENTION

To achieve this object, according to the present invention, when conductive layers are formed along video signal lines at relative positions where the conductive layers are overlapped to portions of the video signal lines [by way of an insulation film], the conductive layers and the video signal lines are electrically connected with each other.

An example of the constitutional features of the present invention will be described.

(One) example of the constitutional features of the present invention is enumerated hereinafter.

(1) In a liquid crystal display device which comprises a plurality of video signal lines and a plurality of pixel electrodes which are arranged in a matrix array and to which video signals are supplied from the video signal lines on one of a pair of substrates [which sandwich] a liquid crystal layer therebetween,

One substrate includes a plurality of conductive layers

which are provided at positions where portions thereof are overlapped to the video signal lines by way of an insulation film, and

the respective conductive layers are electrically connected to the video signal lines.

(2) In the constitution (1), a backlight is provided at a side of one substrate opposite to the liquid crystal layer, and the conductive layer prevents light from the backlight from leaking through a gap defined between two neighboring pixel electrodes.

(3) In the constitution (1) or (2), each conductive layer is electrically connected to the video signal line at one point by way of a contact hole formed in the insulation film.

(4) In the constitution (1) or (2), each conductive layer is electrically connected to the video signal line at two or more points by way of contact holes formed in the insulation film.

(5) In a liquid crystal display device which comprises a plurality of scanning signal lines, a plurality of video signal lines which cross the plurality of scanning signal lines, and a plurality of pixels which are arranged in a matrix array on one of a pair of substrates [which sandwich] a liquid crystal layer therebetween,

each pixel in the plurality of pixels includes a switching element driven by the scanning signal line and a pixel electrode

to which video signals are supplied from the video signal line through the switching element [A];

the one substrate includes opaque conductive layers at relative positions where portions thereof are overlapped to the video signal lines by way of an insulation film, such that the opaque conductive layers are arranged closer to the one substrate side than the video signal lines [B]; and

each opaque conductive layer has a portion which has a width greater than the width of the video signal line, each opaque conductive layer is partially overlapped to both of pixel electrodes of two neighboring pixels arranging the video signal line therebetween, and each opaque conductive layer is electrically connected to the video signal line.

(6) In the constitution (5), each opaque conductive layer is electrically connected to the video signal line at one point by way of a contact hole formed in the insulation film.

(7) In the constitution (5), each opaque conductive layer is electrically connected to the video signal line at two or more points by way of contact holes formed in the insulation film.

(8) In any one of the constitutions (5) to (7), the video signal line and the opaque conductive layer are electrically connected to each other via a contact hole formed in the insulation film, and the video signal line has a larger width at a portion thereof corresponding to the contact hole than

~~the~~
[a] width at other portions thereof.

(9) In any one of the constitutions (5) to (8), the video signal line has at least a portion which has a width equal to or smaller than a gap between pixel electrodes of two neighboring pixels which ^a [arrange the] ^{arranged} video signal line therebetween.

(10) In any one of the constitutions (5) to (9), an area of a portion where the opaque conductive layer and the pixel electrode are overlapped ^{relative} to each other is larger than [an] ^{the} area of a portion where the video signal line and the pixel electrode [are] overlap ~~area~~.

(11) In any one of the constitutions (5) to (10), the opaque conductive layer is formed of the same material as the scanning signal line.

(12) In any one of the constitutions (5) to (11), the liquid crystal display device includes a plurality of capacitance lines for forming storage capacitances in the respective pixels, and the opaque conductive layers are formed of the same material as the capacitance lines.

(13) In any one of the constitutions (5) to (12), the opaque conductive layers are formed in independent patterns corresponding to a gap between two neighboring pixels.

(14) In any one of the constitutions (5) to (13), the pixel electrode is a transparent electrode.

(15) In any one of the constitutions (5) to (13), the pixel electrode is a reflective electrode.

(16) In any one of the constitutions (5) to (13), the pixel electrode is a reflective electrode and each pixel includes a second pixel electrode which is formed of a transparent electrode and to which the video signals are applied.

(17) In the constitution (16), the opaque conductive layer is formed at a position where the opaque conductive layer [is] ^{with} does not overlap ~~with~~ (to) the second pixel electrode.

(18) In either one of the constitutions (16) and (17), a step portion is formed between the transparent electrode in a light transmitting region and the reflective electrode in a light reflective region, and ^{the} thickness of the liquid crystal layer in the light transmitting region is greater than [a] ^{the} thickness of the liquid crystal layer in the light reflective region.

(19) In any one of the constitutions (5) and (18), [a] ^{the} distance from the opaque conductive layer to the pixel electrode as measured in the vertical direction with respect to the substrate is set ^{to be} greater than [a] ^{the} distance from the video signal line to the pixel electrode as measured in the vertical direction with respect to the substrate.

(20) In any one of the constitutions (5) and (19), the liquid crystal display device includes a backlight.

[Here] The present invention is not limited to the above-mentioned constitutions and they can be properly modified without departing from the technical concept of the present

invention.

BRIEF DESCRIPTION OF THE DRAWINGS

Diagrammatic
Fig. 1 is a plan view showing one example of the [schematic] constitution of a pixel according to [the] first embodiment of the liquid crystal display device of the present invention.

Fig. 2 is a cross-sectional view taken along a line A-A' in Fig. 1.

Diagrammatic
Fig. 3 is a plan view showing one example of the [schematic] constitution of the pixel according to [the] second embodiment of the liquid crystal display device of the present invention.

Fig. 4 is a cross-sectional view taken along a line B-B' in Fig. 3.

Diagrammatic
Fig. 5 is a plan view showing one example of the [schematic] constitution of the pixel according to [the] third embodiment of the liquid crystal display device of the present invention.

Diagram
Fig. 6 is a view showing one example of a display screen in which [a] vertical smear is generated.

Fig. 7 is an equivalent circuit diagram of [the] pixel.
Diagram showing
Fig. 8 is a waveform chart for explaining signal waveforms in a region where [the] vertical smear is generated.

Diagram showing
Fig. 9 is a waveform chart for explaining signal waveforms in a region where [the] vertical smear is not generated.

Diagrammatic plan overall
Fig. 10 is a view showing the [whole schematic] constitution of the TFT substrate in [the] fourth embodiment of the liquid

crystal display device of the present invention.

Fig. 11 is a ^{diagram} view showing the ^{overall} schematic constitution in ^a fifth embodiment of the liquid crystal display device of the present invention.

^{Diagrammatic plan}

Fig. 12 is a ^a plan view showing one example of the ^{schematic} constitution of ^a pixel according to ^a sixth embodiment of the liquid crystal display device of the present invention.

Fig. 13 is a cross-sectional view taken along a line C'-C in Fig. 12.

Fig. 14 is a cross-sectional view taken along a line D'-D in Fig. 12.

^{Diagrammatic}

Fig. 15 is a ^a plan view of a pixel portion [for explaining] of a previously proposed display device ^(the schematic constitution of the prior art 1).

Fig. 16 is a cross-sectional view taken along a line E-E' in Fig. 15.

^{Diagrammatic}

Fig. 17 is a ^a plan view of a pixel portion [for explaining] of a previously proposed display device ^(the schematic constitution of the prior art 2).

DESCRIPTION OF THE PREFERRED EMBODIMENTS

Preferred embodiments of the present invention [are] well explained in detail in conjunction with drawings.

[First Embodiment]

^{Diagram}

Fig. 1 is a ^a plan view showing one example of the ^{schematic} constitution of a pixel according to ^a first embodiment of ^{the} liquid crystal display device of the present invention.

Fig. 2 is a cross-sectional view taken along a line A-A' in Fig. 1.

As shown in Fig. 1 and Fig. 2, the liquid crystal display device of this embodiment includes a plurality of video signal lines DL and a plurality of pixel electrodes PX, which are arranged in a matrix array and to which video signals are supplied from the video signal lines DL on one substrate SUB1 [out] of a pair of substrates, which sandwich a liquid crystal layer LC (not shown in the drawing). The substrate SUB1 is preferably made of an insulating transparent material. ^{therebetween} ^{In this regard} That is, the substrate SUB1 may be formed of a glass substrate or a plastic substrate. The counter substrate SUB2 (not shown in the drawing), which constitutes ^{the} other substrate of ^{the} pair of substrates, is formed in the same manner. Further, the pixel electrode PX is formed of a transparent electrode made of ITO (Indium Tin Oxide) or the like, for example.

[Then] A plurality of conductive layers are formed at positions where the conductive layers have portions thereof ^{which} overlap ~~with~~ ^{with} the video signal lines DL ^{and are separated therefrom} by way of an insulation film IN1. These conductive layers are formed of an opaque material, ^{they} and are capable of functioning as light shielding films. In the drawing, the conductive layers are indicated by symbol SLD, and, hereinafter, these conductive layers ^{will be} ^{are} referred to as [the] light shielding films SLD.

as seen in Fig. 2,
Here, ^A the light shielding films SLD are respectively

^{respective}
electrically connected to [the] video signal lines DL.

In this manner, when a plurality of conductive layers (light shielding films SLD) are formed at positions where the conductive layers have portions thereof, overlap ~~with~~ to the video signal lines DL, by way of the insulation film IN1 and, along the video signal lines DL, by electrically connecting the conductive layers (light shielding films SLD) with the video signal lines DL, it is possible to prevent the conductive layers from assuming a floating state. Further, since the potential of the conductive layer is not different from the potential of the video signal lines DL, it is possible to reduce the increase of ^{or avoid any} the load or rounding of waveforms, which have occurred conventionally at the time of driving the video signal lines DL, as in the case of the ^{the display device described in the afore-mentioned publication} prior art. Due to such a constitution, it is possible to provide a display having a favorable image quality.

In this embodiment, as a method [for] of electrically connecting the conductive layers and the video signal lines DL, an example which establishes the electric connection using contact holes CH1 formed in the insulation film IN1 is shown. In this embodiment, each light shielding film SLD is connected to [the] video signal line DL at one position.

Here, when the light shielding films SLD can be formed using the same material as the scanning signal lines GL, both of them can be formed simultaneously, and, hence, ^{any} (the) increase

steps in the manufacture
of the number of processing ^Acan be prevented. Gate electrodes GT can be formed simultaneously with the scanning signal lines GL.

each
In this embodiment, [the] pixel includes a plurality of storage lines STL for forming storage capacitances Cstg (not shown in the drawing). By forming the light shielding films SLD using the same material as the storage lines STL, they can be formed simultaneously and hence, [the] increase of the number ^Aof processing ^{an}can be prevented. In place of forming the storage capacitances Cstg using the storage lines STL, it is also possible to form additional capacitances Cadd by making use of the scanning signal lines GL of ^Apreceding stage, and hence, the storage lines STL are not indispensable in this embodiment.

Three components, consisting of the light shielding films SLD, the scanning signal lines GL and the storage lines STL, can be formed simultaneously using the same material.

When the light shielding films SLD are formed simultaneously with the scanning signal lines GL and the storage lines STL, the light shielding films SLD cannot ^{pass} [get] over these lines. Accordingly, a plurality of light shielding films are formed in patterns independent from each other corresponding to each gap defined between two neighboring pixels.

In a plurality of pixels which are arranged in a matrix array, each pixel includes a switching element (not shown in the drawing) which is driven by [the] scanning signal line GL and

[the] pixel electrode PX, to which the video signals are supplied from the video signal lines DL through the switching element. As the switching elements, for example, thin film transistors (TFT) or the like can be used.

Here, it is preferable that the video signal line DL has the width W1 of at least a portion thereof set to a value equal to or smaller than [a] gap defined between the pixel electrodes PX of two neighboring pixels, which are arranged close to each other while sandwiching the video signal line DL therebetween. Due to such a constitution, the video signal line DL is not overlapped [to] the pixel electrodes PX, as indicated by L1 in Fig. 2, and, hence, parasitic capacitances, which are generated by the video signal line DL, the pixel electrodes PX and a second insulation film IN2 disposed between the video signal line DL and the pixel electrodes PX, can be reduced, whereby [the] vertical smear can be reduced, as will be explained later.

However, with the provision of only such a constitution, light irradiated from a backlight BL (not shown in the drawing) still can leak through portions L1. Accordingly, [a] width W2 of the light shielding film SLD is set to a value greater than the width W1 of the video signal line DL, such that the portions of the light shielding film SLD [are] overlapped [to] both of the pixel electrodes PX of two neighboring pixels, which are arranged close to each other, while sandwiching the video signal lines DL therebetween, as indicated by L2 in Fig. 2. Due to such a

constitution, the light shielding film SLD can prevent light irradiated from the backlight BL from leaking through the gap defined between [the] neighboring ^{two} pixel electrodes PX.

Here, since the light shielding film SLD is electrically connected to the video signal line DL, [the] parasitic capacitance is generated between the light shielding film SLD and the pixel electrode PX. However, since the light shielding film SLD is formed at the substrate SUB1 side ^a [by way of] the video signal line DL and ^{below} the insulation film IN1, [a] total film thickness of the insulation films, with respect to the light shielding film SLD, is made larger than [a] total film thickness of the insulation films with respect to the video signal line DL. That is, the distance from the light shielding film SLD to the pixel electrode PX, as measured in the vertical direction with respect to the substrate SUB1, in the regions where the light shielding film SLD ^s overlaps ~~with~~ ^{to be} the pixel electrodes PX, is set greater than the distance from the video signal line DL to the pixel electrode PX, as measured in the vertical direction with respect to the substrate SUB1. In this manner, since the distance from the light shielding film SLD to the pixel electrodes PX is ^{more} remote than the distance from the video signal line DL to the pixel electrodes PX, the generation of parasitic capacitance can be suppressed.

As described above, according to the present invention, it is possible to provide ^a [the] display device having improved

image qualities.

[Second Embodiment]

Diagram

Fig. 3 is a plan view showing one example of the [schematic] constitution of [the] pixel according to [the] second embodiment of the liquid crystal display device of the present invention. Fig. 4 is a cross-sectional view taken along a line B-B' in Fig. 3. In this embodiment, parts which are common with the parts of the first embodiment are indicated by the same symbols, and [their] repeated explanation is omitted.

This embodiment is substantially equal to the first embodiment. The point which makes the second embodiment different from the first embodiment lies in that the partially transmissive pixel structure is adopted. Each pixel includes a reflective region and a transmissive region (light transmitting region) in a pixel region. A reflective electrode PXR is formed as the pixel electrode in the reflective region, and performs the display by reflecting light incident from the counter substrate SUB2 side. On the other hand, in the transmissive region, a transparent electrode PXT is formed as a second pixel electrode to which the video signals are supplied. The transmissive region is formed such that, for example, an opening OP1 is formed in the reflective electrode PXR so as to optically expose the transparent electrode PXT. Thus, the display is performed by allowing light from the backlight BL, which is incident from the substrate SUB1 side, to pass

therethrough.

In Fig. 4, one example of [the] structure is shown. This structure is constituted as follows. [That is,] After forming the second insulation film IN2, the transparent electrode PXT is formed. Then, a third insulation film IN3 is formed, and the reflective electrode PXR is formed over the third insulation film IN3. In the transmissive region, by forming an opening OP2 in the third insulation film IN3, a stepped portion is formed between the transmissive region and the reflective region, so that [a] thickness d_t of the liquid crystal layer LC in the transmissive region is [set] greater than [a] thickness d_r of the liquid crystal layer LC in the reflective region. This provision is [made] to approximate the respective optical characteristics of the transmissive region and the reflective region to each other by adjusting the optical path lengths of the transmissive region and the reflective region.

In this embodiment, the transparent electrode PXT, which constitutes the second pixel electrode, and the light shielding film SLD are positioned such that they [are] not overlap [to] each other, as indicated by L_3 in Fig. 4. Due to such an arrangement, it is possible to reduce the parasitic capacitance.

In this embodiment, the reflective electrode PXR constitutes a portion which corresponds to the pixel electrode PX in the first embodiment. However, [this embodiment] is not limited to such a structure, and it is needless to say that the

can be
structure [is] suitably modified such that the transparent electrode PXT may be used as a portion which corresponds to the pixel electrode PX in the first embodiment.

In Fig. 4, one example of the structure of the counter substrate SUB2 is also illustrated. Over the counter substrate SUB2, color filters FIL, a leveling film OC and a counter electrode CT are formed. A common potential Vcom is supplied to the counter electrode CT. This structure is also adopted by other embodiments, including the first embodiment. Although orientation films and polarizers are further *also* provided, they have been omitted from the drawing. These structures merely constitute one example and can be suitably modified when necessary.

[Third Embodiment]

Diagram
Fig. 5 is a [plan view] showing one example of the [schematic] constitution of [the] pixel according to [the] third embodiment of the liquid crystal display device of the present invention. In this embodiment, parts which are common with the parts of the other embodiments which have been explained heretofore are indicated by *the* same symbols, and [their] repeated explanation is omitted.

Although the basic constitution of this embodiment is equal to that of the first embodiment, this embodiment differs from the first embodiment in that the video signal line DL and each conductive layer (light shielding film SLD) are connected

to each other at two portions using two contact holes CH1.

Accordingly, the video signal line DL and the light shielding film SLD are connected in parallel, and, hence, this gives rise to an advantageous effect ⁱⁿ that the resistance can be reduced.

Further, even when a disconnection occurs at a portion, since ^a bypass is formed, it is possible to ^{produce} [perform] a display. To obtain these advantageous effects, it is preferable to set the connection portions at positions in the vicinity of the end ^{which are spaced} portion of the light shielding film SLD [and apart] from each other, as shown in Fig. 5.

The number of connection portions is not limited two, and ^{thus} may be three or more. Further, the structure of this embodiment is also applicable to the second embodiment.

[Principle of generation of vertical smear and reduction of vertical smear]

Fig. 6 is a ^{diagram} showing one example of a display screen in which ^a vertical smear is generated. Fig. 7 is an equivalent circuit of ^{the} pixel. Fig. 8 is a waveform diagram [for explaining] showing the signal waveform in a region where ^{the} vertical smear is generated. Fig. 9 is a waveform diagram [for explaining] showing the signal waveform in a region where ^{the} vertical smear is not generated.

Fig. 6 shows an example in which display regions AR1, AR3 are set to assume a half tone display of the same level as ^{the} background, and a rectangular white display window is ^{provided} [displayed] in a display region AR2. Originally, the display

regions AR1, AR3 are expected to have the same half tone level. However, in the display regions AR3 which are arranged above and below the display region AR2 (in the vertical direction), the tone is shifted to the white display level ^{from} [than] the original half tone level. This phenomenon is referred to as [the] vertical smear.

As shown in Fig. 7, in the equivalent circuit of [the] pixel, the video signals are written in the pixel electrode PX (not shown in the drawing) from the video signal line DL through the thin film transistor TFT, which constitutes a switching element driven by the scanning signals ^{supplied} from the scanning signal line GL. The pixel electrode PX forms a liquid crystal capacitance Clc between the pixel electrode PX and the counter electrode CT [by way of] a liquid crystal layer LC. Further, [the] storage capacitance Cstg is connected between the pixel electrode PX and the storage line STL so that the voltage of the written video signal can be held for a relatively long time. Further, [the] parasitic capacitance Cds is generated between the pixel electrode PX and the video signal line DL.

In Fig. 8, time t is taken on an axis of abscissas and a potential V is taken on an axis of ordinates. In the waveform chart shown in Fig. 8, alternating is performed by reversing the polarities with respect to the common potential Vcom of the video signal for every 1 frame period FL. To focus on [the] specific pixel in the display region AR3 in which [the] vertical smear

is generated, with respect to the scanning signal line potential VGL of the row, the selection level of the scanning signal is applied for every frame period FL. A fixed common potential Vcom is applied to the counter electrode CT. At the beginning, the video signal line potential VDL assumes a certain half-tone potential as the video signal. Then, when the thin film transistor TFT assumes the ON state in synchronism with ^{receipt of} the scanning signal, a pixel electrode potential VPX of the specified pixel follows the video signal line potential VDL. When the supply of the scanning signals is finished and the thin film transistor TFT is turned OFF, the pixel electrode PX tries to hold the potential.

However, when the scanning sequentially advances and the scanning of the display region AR2 is about to be performed, the video signal line potential VDL is changed to the potential of the white display level. Here, due to the presence of ^{the} parasitic capacitance Cds, the pixel electrode potential VPX of the previously-mentioned specified pixel is also changed correspondingly. This brings about the vertical smear. ^{phenomenon} ↗

On the other hand, as shown in Fig. 9, since ^{when} the video signal line potential is not changed during 1 frame period FL in the display region AR1, the pixel electrode potential VPX ^{also} is not [also] changed.

Here, the voltage change level ΔV attributed to ^{the} vertical smear can be expressed by ^{the} following formula, provided

that the difference between the pixel electrode potential VPX and the video signal line potential VDL is set as V_t .

$$\Delta V = C_{ds} / (C_{stg} + C_{lc} + C_{ds}) \times V_t$$

Accordingly, to decrease the voltage change level ΔV , it is possible to [take] either [one of] decreasing the parasitic capacitance C_{ds} [and] increasing the storage capacitance C_{stg} + liquid crystal capacitance C_{lc} .

When the definition of the liquid crystal panel is increased, the pixel size becomes miniaturized, and, hence, [in] the inside of the pixel, the area for forming the storage capacitance C_{stg} and the area for forming the liquid crystal capacitance C_{lc} are restricted. Accordingly, in such a case, it is advantageous to apply the present invention which can reduce the parasitic capacitance C_{ds} .

When [the] polycrystalline silicon is used as [a] material for a semiconductor layer of the thin film transistor TFT which constitutes the switching element, [the] high definition can be realized. In such a case, it is preferable to apply the present invention [which] can reduce [the] vertical smear. It is needless to say that the present invention is not limited to such a case, and the present invention is naturally applicable to a case in which amorphous silicon is used as [a] material of the semiconductor layer.

[Fourth Embodiment]

Fig. 10 is a [view] showing the [whole schematic] constitution

of the TFT substrate in [the] fourth embodiment of the liquid crystal display device of the present invention.

On one substrate SUB1 [out] of a pair of substrates [which] ^{having} _{sandwiched} [sandwich] a liquid crystal layer LC therebetween, a plurality of scanning signal lines GL, a plurality of video signal lines DL which cross the plurality of scanning signal lines GL, and a plurality of pixels (not shown in the drawing) which are arranged in a matrix array in the display region AR are formed. Storage lines STL for generating the storage capacitance Cstg are also formed on the substrate SUB1 and a common potential Vcom is applied to the storage lines STL.

A scanning signal driving circuit GDR, which ^{supplies} _{applies} scanning signals, is connected to the scanning signal lines GL and sequentially performs [the] scanning. A video signal driving circuit DDR, which ^{supplies} _{applies} video signals, is connected to the video signal lines DL.

Either one or both of the scanning signal driving circuit GDR and the video signal driving circuit DDR can be directly formed on the substrate SUB1 in parallel with ^{the} step _{for} forming the thin film transistors TFT in the pixels, using thin film transistors made of polycrystalline silicon, so as to assemble a peripheral circuit incorporated type liquid crystal display device. ^{However,} The present invention is not limited to such a liquid crystal display device. That is, these driving circuits may be supplied in ^{the} form of semiconductor integrated circuit chips

and may be directly mounted on the substrate SUB1, or, may be connected to the substrate SUB1 using a flexible printed circuit board (FPC) or a tape carrier package (TCP).

[Fifth Embodiment]

Fig. 11 is a ^{diagram} ^{overall} view showing the whole schematic constitution of [the] fifth embodiment of the liquid crystal display device of the present invention.

In Fig. 11, a substrate SUB1 and a counter substrate SUB2 are laminated to each other using a sealing material SL (while), with ^{being sandwiched}, to form a liquid crystal display panel sandwiching a liquid crystal layer LC therebetween. Further, a backlight BL is arranged at a side of the substrate SUB1 opposite to the liquid crystal layer LC, and illuminates the liquid crystal display panel from the back side (side opposite to a viewer).

This embodiment illustrates a case which adopts a partial transmissive type liquid crystal display device, so that it is also possible to perform the display by reflecting light incident from the counter substrate SUB2 side. This embodiment is not limited to such a liquid crystal display device. That is, this embodiment may be applied to the transmissive type liquid crystal display device.

[Sixth embodiment]

Fig. 12 is a ^{diagram} plan view showing one example of the schematic constitution of [the] pixel in [the] sixth embodiment of the liquid crystal display device of the present invention. Fig. 13 is a cross-sectional view taken along a line C-C' in Fig. 12. Fig.

14 is a cross-sectional view taken along a line D-D' in Fig.

12. In this embodiment, parts which are common with the parts of the other embodiments which have been explained heretofore are indicated by ^{the} same symbols, and ^{their} ~~a~~ repeated explanation ^{therefore} ~~is~~ omitted.

The constitution ^{shown} in Fig. 12 (which) differs from the constitutions of other embodiments ^{the} [lies] in that ^{the} width of the video signal line DL is not fixed. Particularly, at a portion of a contact hole CH1, through which an electrical connection between the video signal line DL and a light shielding film SLD is established, the video signal line DL has a larger width than ^{the} width in other portions thereof. This provision is ^{feature} ~~made~~ ^{provided} ^{a sufficient} ^{make} to ensure ^{the} connection area and to ^{possibility of} perform ^a the connection surely by taking ^{the} misalignment or the like into consideration.

In this case, since the parasitic capacitance Cds between the video signal line DL and the pixel electrode PX (in this embodiment, reflective electrode PXR) is increased, it is preferable to set the number of connection portions ^{to a number} as small ^a as possible. Accordingly, this embodiment adopts ^{the} structure which connects the video signal line DL and a light shielding film SLD only at one portion.

From ^{the} viewpoint of reducing the parasitic capacitance Cds, it is preferable that ^{the} area of the portion where the light shielding film SLD and the pixel electrode PX (reflective electrode PXR) ^{to be} overlap ~~to~~ each other is set ^a larger than

~~the~~
[an] area of the portion where the video signal line DL and the pixel electrode PX (reflective electrode PXR) [are] overlap ~~with~~
[to] each other.

Further, at portions where the light shielding film SLD is not formed, the width of the video signal line DL is increased and [is] overlap ⁵ with the pixel electrode (reflective electrode PXR), thus performing the light shielding.

Next, one example of the structure of the thin film transistor TFT, which constitutes one example of the switching element used in [the] pixel [is] explained. (The) explanation is made in conjunction with a case in which polycrystalline silicon is used as ~~a~~ material of a semiconductor layer of the thin film transistor TFT.

Over a semiconductor layer, a gate electrode GT is formed by way of a gate insulation film GI. A semiconductor layer below the gate electrode GT constitutes a channel region PSC. Further, a drain region SD1 and a source region SD2 are formed by doping impurities into the semiconductor layer. In the vicinity of an end portion of the gate electrode GT, an LDD (Lightly Doped Drain) region LDD, which is doped with impurities having a concentration ^{that is} lower than the concentration of the impurities doped in the drain region SD1, and the source region SD2 is formed. In place of such a structure, it is also possible to form an offset region which exhibits the same state as the channel region PSC. A first insulation film IN1 is formed such

that the first insulation film IN1 covers them. To the drain region SD1, a drain electrode SD3, which is formed integrally with the video signal line DL through the contact hole CH2, is connected. On the other hand, to the source region SD2, a source electrode SD4 is connected by way of the contact hole CH3. A second insulation film IN2 is formed such that the second insulation film IN2 covers them. Over the second insulation film IN2, a transparent electrode PXT is formed, and the transparent electrode PXT is connected to the source electrode SD4 by way of the contact hole CH4. A third insulation film IN3 is formed above such ^{elements} [a constitution]. Above the third insulation film IN3, a reflective electrode PXR is formed. Here, the reflective electrode PXR is connected with the transparent electrode PXT in an opening OP2 formed in the third insulation film IN3. However, ^{that is}, thin film transistor is not limited to such a constitution. That is, another contact hole may be formed, and the reflective electrode PXR ^{may be} is connected to the transparent electrode PXT or the source electrode SD4 using such a contact hole.

In Fig. 14, the storage line STL generates the storage capacitances Cstg between the storage line STL and the capacitance electrode PSE, between the storage line STL and the source electrode SD4, and between the storage line STL and the transparent electrode PXT. Here, the capacitive electrode PSE is a semiconductor layer which becomes conductive by being

doped with impurities and is integrally formed with the source region SD2. As the structure of the storage capacitance Cstg, various structures can be used besides the structure of this embodiment, and, also, they can be modified suitably.

The constitutional features of any one of the above-mentioned first to sixth embodiments can be combined with the constitutional features of one or more embodiments unless the combination induces ^a contradiction.

As has been explained heretofore, according to the present invention, it is possible to obtain ^a [the] display device with improved image qualities.